

KetaSpire[®] KT-851

polyetheretherketone

KetaSpire® KT-851 resin is a depth-filtered grade of polyetheretherketone (PEEK) specially designed for use in extruded wire insulation coating. KT-851 offers the needed balance of properties and processability for applying thin insulation coatings onto copper or other conducting wire using a continuous extrusion process to achieve a robust insulation coating that is capable of withstanding the harsh use environments of many industrial applications.

KetaSpire® PEEK is produced to the highest industry standards and is characterized by a distinct

combination of properties, which include excellent chemical resistance to organics, acids and bases, best in class fatigue resistance, excellent wear resistance, ease of melt processing and high purity.

The pellets are supplied with a very light dusting (0.01%) of calcium stearate to aid with conveying through single screw extruder-based processing equipment.

Natural: KetaSpire® KT-851 NT

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001	or or	

General		
Material Status	 Commercial: Active 	
Availability	 Africa & Middle East Asia Pacific Europe 	 Latin America North America
Additive	• Lubricant	
Features	 Chemical Resistant Ductile Fatigue Resistant Flame Retardant 	 Good Dimensional Stability Good Impact Resistance High Heat Resistance
Uses	 Electrical/Electronic Applications Oil/Gas Applications 	• Wire Jacketing
Agency Ratings	• ISO 10993	
RoHS Compliance	Contact Manufacturer	
Appearance	Natural Color	
Forms	Pellets	
Processing Method	Injection MoldingMachining	Profile Extrusion
	-	

Physical	Typical Value Unit	Test method
Density / Specific Gravity	1.30	ASTM D792
Melt Mass-Flow Rate (MFR) (400°C/2.16 kg)	10 g/10 min	ASTM D1238
Molding Shrinkage		ASTM D955
Flow	1.1 to 1.3 %	
Across Flow	1.3 to 1.5 %	
Water Absorption (24 hr)	0.10 %	ASTM D570

Mechanical	Typical Value	Unit	Test method
Tensile Modulus			
1	3600	MPa	ASTM D638
	3850	MPa	ISO 527-1/1A/1
Tensile Stress			
Yield	95.0	MPa	ISO 527-2/1A/50
	96.0	MPa	ASTM D638
Tensile Elongation			
Yield ²	5.2	%	ASTM D638
Yield	4.8	%	ISO 527-2/1A/50
Break ²	20 to 30	%	ASTM D638
Break	20 to 30	%	ISO 527-2/1A/50
Flexural Modulus			
	3900	MPa	ASTM D790
	3620	MPa	ISO 178
Flexural Strength			
	152	MPa	ASTM D790
	112	MPa	ISO 178
Compressive Strength	121	MPa	ASTM D695
Shear Strength	91.5	MPa	ASTM D732
Impact	Typical Value	Unit	Test method
Notched Izod Impact		,	
		J/m	ASTM D256
	7.5	kJ/m²	ISO 180
Unnotched Izod Impact			
	No Break		ASTM D4812
		kJ/m²	ISO 180
Hardness	Typical Value	Unit	Test method
Rockwell Hardness (M-Scale)		OTIL	ASTM D785
Durometer Hardness (M Scale)	88		ASTM D783
	00		A311VI D2240
Thermal	Typical Value	Unit	Test method
Deflection Temperature Under Load ³			ASTM D648
1.8 MPa, Annealed, 3.20 mm	157	°C	
Glass Transition Temperature	150	°C	ASTM D3418
Peak Melting Temperature	340	°C	ASTM D3418
CLTE - Flow (-50 to 50°C)		cm/cm/ºC	ASTM E831
Specific Heat			DSC
50°C	1350	J/kg/ºC	200
200°C		J/kg/°C	
Thermal Conductivity		W/m/K	ASTM E831
	0.24		

Electrical	Typical Value Unit	Test method
Surface Resistivity	> 1.9E+17 ohms	ASTM D257
Volume Resistivity	2.5E+17 ohms·cm	ASTM D257
Dielectric Strength		ASTM D149
0.0500 mm, Amorphous Film	200 kV/mm	
Fill Analysis	Typical Value Unit	Test method
Melt Viscosity (400°C, 1000 sec^-1)	380 Pa·s	ASTM D3835

Additional Information

Standard Packaging and Labeling

• KetaSpire resins are packaged in polyethylene buckets or cardboard boxes depending upon the order size. Individual packages will be plainly marked with the product, color, lot number, and net weight.

Injection	Typical Value Unit	
Drying Temperature	150 °C	
Drying Time	4.0 hr	
Rear Temperature	355 °C	
Middle Temperature	365 °C	
Front Temperature	370 °C	
Nozzle Temperature	375 °C	
Mold Temperature	175 to 205 °C	
Injection Rate	Fast	
Screw Compression Ratio	2.5:1.0 to 3.5:1.0	

Injection Notes

Drying

• KetaSpire resins must be dried completely prior to melt processing. Incomplete drying will result in defects in the formed part ranging from surface streaks to severe bubbling. Pellets can be dried on trays in a circulating air oven or in desiccating hopper dryer. Drying conditions recommended are 4 hours at 150°C (300°F).

Injection Molding

KetaSpire resins can be readily injection molded in most screw injection machines. A general purpose screw with a compression ratio in the range of 2.5 - 3.5 : 1 is recommended, as is minimum back pressure. Injection speeds should be as fast as possible, consistent with part appearance requirements. Mold temperatures in the range of 175°C to 205°C (350°F to 400°F) are suggested. Recommended starting point barrel temperatures are shown in the following table.

Notes

Typical properties: these are not to be construed as specifications.

¹ 1.0 mm/min

² 50 mm/min

³ 2 hours at 200°C

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